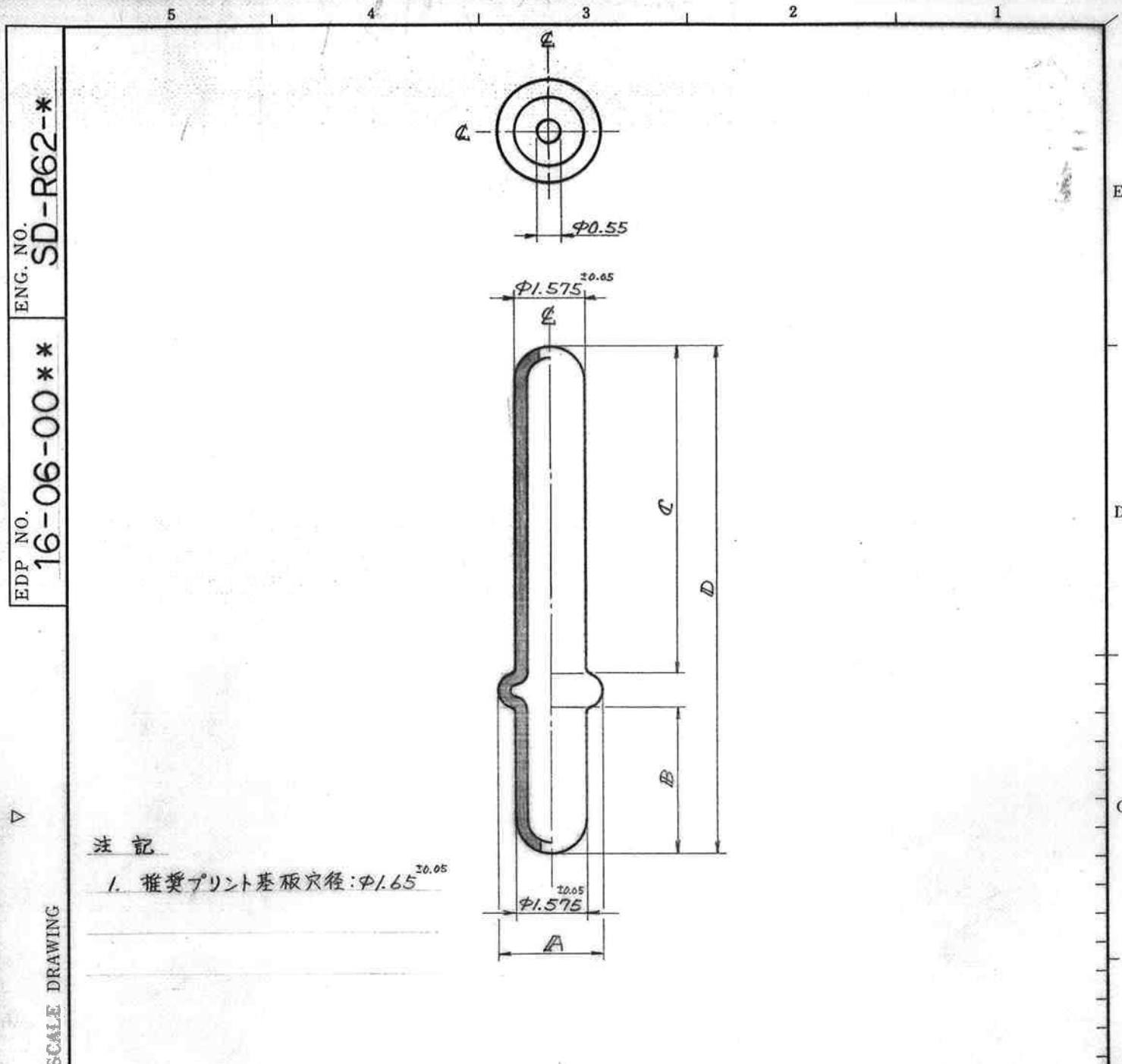


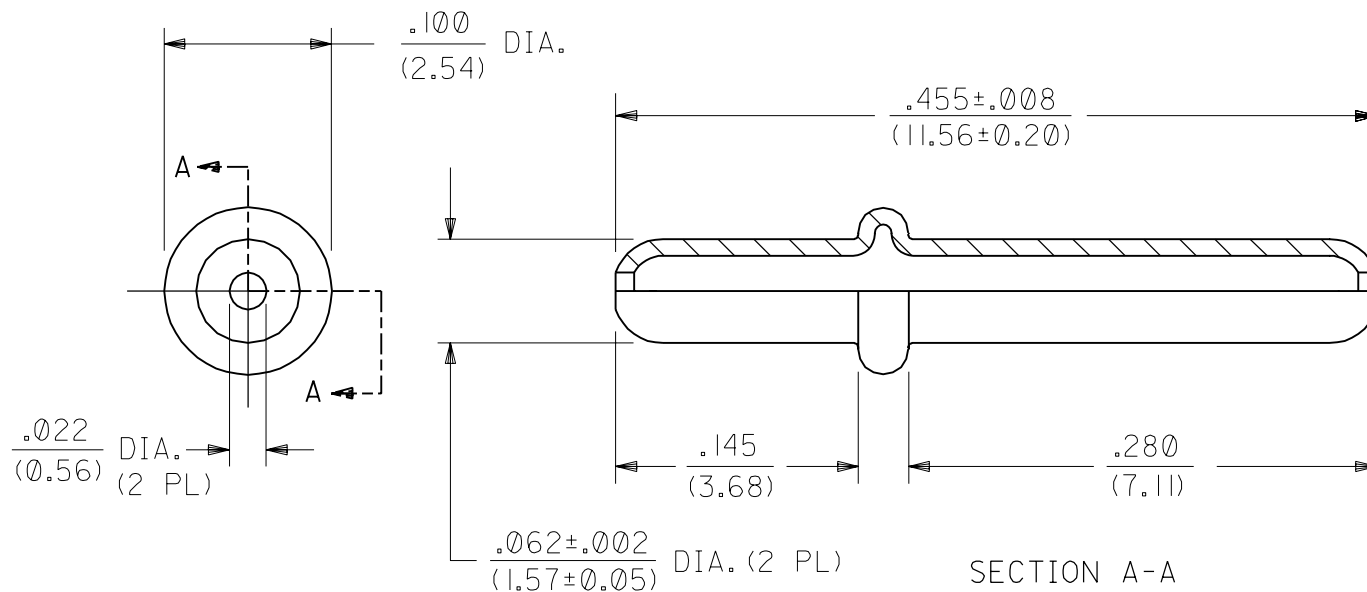


注記

1. 推奨プリント基板穴径: $\phi 1.65^{+0.05}$

単位: MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING

角度	ANGLE	$\pm 3^\circ$	16-06-0010	R62-5	$\phi 2.55$	3.68	7.1	11.55	錫メッキ(3 μ MIN.)	
30 以上	OVER	± 0.3								
10 以上	OVER	± 0.25	16-06-0011	-4	$\phi 2.28$	3.18	10.15	14.1	錫メッキ(3 μ MIN.)	
30 未満	UNDER									
10 未満	UNDER	± 0.2	16-06-0004	R62-3	$\phi 2.29$	3.18	7.11	11.05	錫メッキ(3 μ MIN.)	
10 未満	UNDER									
一般公差			EDP NO.	ENG. NO.	A	B	C	D	メッキ仕様	備考
GENERAL TOLERANCES										
			材料 MATERIAL							
			貴銅							
			仕上 FINISH							
			表参照							
			適用電線範囲 WIRE RANGE							
			被覆外径 INS. RANGE							
			DRAWN BY							
			CHK'D BY							
			APP'D BY							
			尺 度 SCALE							
			8-1							
D	REVISED	ECN No. 2395	MS	4/1/82	TITLE 名称:					
C	REDRAWN	ECN No. 789	MS	9/25/78	BEAD PIN					
記号	変更内容	DR.	日付	DATE						
LTR	REVISION RECORD	CHK.								



NOTES:

1. MATERIAL: CARTRIDGE BRASS, ALLOY #C26000.
2. FINISH: .000200/(0.00508) MIN. ELECTRO TIN PLATE.

A

NEW SALES DWG.
ECN U2 0738
5-7-92 RW

MFG.	SH.	REV.	LTR.	REVISIONS

DIMENSIONS SHOWN (METRIC) INCH			
UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR $\pm 1/2^\circ$			
	INCH	METRIC	
3 PLACE	$\pm .010$	---	
2 PLACE	$\pm .014$	± 0.25	
1 PLACE	---	± 0.36	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			
DRWG. BY	RW	CHK'D. BY	RW
APP'D. BY	RAS	SCALE	10:1

$\nabla = 0$

$\blacktriangledown = 0$

REVISE ONLY ON CAD SYSTEM

TITLE

$\frac{.062}{(1.57)}$ DIA. PIN FOR
P.C. BOARD MOUNTING

MOLEX INCORPORATED
LISLE, ILL. 60532 U.S.A.

SHEET NO. 1 OF 1
DATE 5/7/92

PART NO.

16-06-0010

DRWG. NO.

SDSP-599

FILE NAME
S599X1
DGN

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO
MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.

DIV.
CP

SIZE
A